

TED STATES PATENT AND TRADEMARK OFFICE

In re patent of

Attn: Certificate of

Correction Branch

Shoriki NARITA et al.

Patent No. 7,014,092

Atty Docket No. 2003 1226

Issued March 21, 2006

Confirmation No. 7745

BUMP FORMING APPARATUS FOR CHARGE APPEARANCE SEMICONDUCTOR SUBSTRATE, CHARGE REMOVAL METHOD FOR CHARGE APPEARANCE SEMICONDUCTOR SUBSTRATE, CHARGE REMOVING UNIT FOR CHARGE APPEARANCE SEMICONDUCTOR SUBSTRATE, AND CHARGE APPEARANCE SEMICONDUCTOR SUBSTRATE

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEES FOR THIS PAPER TO DEPOSIT **ACCOUNT NO. 23-0975**

REQUEST FOR CERTIFICATE OF CORRECTION UNDER 37 CFR 1.322

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the provisions of 37 CFR 1.322, it is respectfully requested that a Certificate of Correction issue to correct the following:

Certificate

JUL 1 1 2006

of Correction

JUL 2 - 2006,

IN THE CLAIMS

In claim 5, column 52, line 1:

Please insert comma between "substrate" and "and."

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REMARKS

The above corrections are being made to correct errors made by the USPTO during printing of the above-referenced patent. Accordingly, a Certificate of Correction is respectfully requested, and the Certificate of Correction should issue at no expense to the patentee. Form PTO-1050 accompanies this request, and indicates the requested changes as discussed above.

Respectfully submitted,

Shoriki NARITA et al

W. Douglas Hahm

Registration No. 44,142 Attorney for Patentees

WDH/ck Washington, D.C. Telephone (202) 721-8200 Facsimile (202) 721-8250 July 7, 2006

To: The Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO

7,014,092

DATED

10 0 2 10

March 21, 2006

INVENTOR(S)

Shoriki NARITA et al.

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

IN THE CLAIMS

In claim 5, column 52, line 1:

Please insert comma between "substrate" and "and."

Wenderoth, Lind & Ponack, L.L.P. 2033 K Street, N. W., Suite 800 Washington, D.C. 20006-1021

PATENT NO. 7,014,092

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